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# **AN-9091** Boost PFC Inductor Design Guide for PFC SPM<sup>®</sup> Series

## **System Configurations**

The block diagram in Figure 1 shows PFC SPM® 3 series ver.2, FPAB20BH60B, used in a boost Power Factor Correction (PFC) topology. The inductor (L) is located between pin 24 and pin 25 of the FPAB20BH60B on the boost PFC SPM evaluation board.

Inductor design is crucial to achieving the objective of power factor correction. It should be designed optimally to pass the harmonic guideline without increasing the system cost. Table 1 shows typical operating conditions of the FPAB20BH60B evaluation board under test.



Figure 1. Block Diagram of Boost PFM SPM Evaluation Board

Table 1.	Typical	Operating	Conditions
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No.	Item	Symbol	Value	Unit
1	Switching Frequency	f	22	kHz
2	Normal Input Voltage	V <sub>IN</sub>	220	V <sub>RMS</sub>
3	Output Maximum Power	Po	2200	W
4	Nominal Output Voltage	V <sub>DCOUT</sub>	390	V <sub>DC</sub>

#### **Calculation of Inductance L**

The following equation is used to calculate the inductance value (L) of the inductor. It is obtained from ripple current by the inductor located between the AC input and the DC link voltage. Please refer to <u>AN-42047</u>.

$$\Delta I_{LP_{-P}} = \frac{V_{\mathbb{N}}(V_{OUTDC} - V_{\mathbb{N}})}{fLV_{OUTDC}}, < \frac{V_{OUTDC}}{V_{\mathbb{N}}} = \frac{1}{1 - D},$$

$$\Delta I_{LP_{-P}} = \frac{V_{\mathbb{N}} * D * T}{L}$$
(1)

where:

 $\Delta I_{\text{LP-P}}$ : Peak to peak current of PFC inductor;

V<sub>IN</sub>: Input AC voltage (V<sub>RMS</sub>);

V<sub>OUTDC</sub>: DC link Voltage (V);

f: Switching frequency (Hz); and

L: Inductance of PFC inductor (H).

$$\Delta I_{LP_{-P}} = \frac{V_{N}(V_{OUTDC} - V_{N})}{fLV_{OUTDC}}$$
  
$$\therefore (\Delta I_{LP_{-P}})_{MAX} = \frac{V_{OUTDC}}{4fL}, \therefore V_{N} = \frac{1}{2}V_{OUTDC}$$
(2)

Assuming that f=22 kHz,  $V_{OUTDC}$ =390 V<sub>DC</sub>,  $\Delta I_{LP_P}$ =4.0 A, it's possible to calculate inductance L as follows:

$$L = V_{OUTDC} / (4 \times f \times \Delta I_{LP_P}) = 390 V_{DC} / (4 \times 22kHz \times 4.0A) = 1.108mH$$
(3)

#### **Selection of Wire Diameter**

In the operating conditions of Table 1, the rated output power is 2.4 kW and rated voltage of AC input is 220  $V_{AC}$ . Obtain the maximum input current as:

$$I_{AC MAX} = 2.2kW/220V_{AC} = 10.0Arms$$
 (4)

Assuming that the rms current per square mm of copper wire is 5 [Arms/ mm<sup>2</sup>], the area and diameter of wire are calculated as follows:

$$Aw = I_{AC_{MX}} / (5[A/mm^{2}]) = 2.0mm^{2}$$
(5)

Radius of wire = 
$$SQRT(Aw/3.14)$$
  
=  $SQRT(2.0/3.14) = 0.80[mm]$  (6)

From this, 2.0 mm-diameter copper wire with was chosen.

#### **Core Selection**

There are many things to consider when choosing a core: core material, core permeability, effective cross-section area (cm<sup>2</sup>), magnetic path length (cm), and nominal inductance (nH/N<sup>2</sup>). For performance, a Mega Flux® core was selected.

Core: *CK*740060*C* (7)

Magnetic Path Length I = 18.38cm = 183.8mm (8)

CrossSection Area A  
= 
$$5.04cm^2 = 183.8mm$$
 (9)  
Initialpermeability u =  
 $60 \times 4 \times 3.14 \times 1e - 10(H/mm)$  at  $25kHz$  (10)

#### **Material Properties**

- Chemical composition: Fe Si alloy
- Saturation flux density: 16.000 Gauss
- Curie temperature: 550°C
- Initial permeability: 60 μ ±12%, Measured at 25 kHz, 1 V, and 0 A<sub>DC</sub>

#### Dimensions

#### **Magnetic Dimensions**

- Magnetic Path Length: 18.38 cm
- Cross Section Area: 5.04 cm<sup>2</sup>

### **Physical Dimensions (Case)**

- OD: 79.50 sm (Maximum)
- ID: 41.14 cm (Minimum)
- HT: 55.0 cm (Maximum)

#### Case

- Composition: PBT (POLY BUTHYLENE TERPHTALATE)
- Maker: KOLON
- UL FLAME CLASS & FILE NO: UL 94-VO, E88499



Figure 2. Specification of the Selected Toroidal Core: CK740060C





Figure 3. Core Case Sizes

## **Calculation of Wire Turn Number**

A boost PFC inductor with a toroidal core and its wiring is shown in Figure 4.



Figure 4. Wiring of Boost PFC SPM Inductor with Toroidal Core

In case of inductor, calculate the turn number (N) of each wire using the following equation and referring to website: <u>http://www.changsung.com</u>:

$$L = \frac{0.4\pi\mu N^2 A * 10^{-2}}{1} \tag{11}$$

From the core parameters in Equations (8) - (10), and (11), N is calculated as follows:

$$N = SQRT(1.108 mH \times 183.9)$$

 $(60 \times 4 \times 3.14 \times 10 - 10/H \times 504) = 74 turn$ (12)

From this, choose a turn number above the obtained 74 turns. 74 turns of wire was selected as the final turn number of the boost PFC  $SPM^{\circledast}$  inductor.

## Implementation of PFC Inductor



Figure 5. Top View of Inductor



Figure 6. Copper Wire Width (2.01 mm)



Figure 7. Inductance of Inductor (0.98 mH)

According to calculation, the selected copper wire is 2.0 mm and inductance is 1.1 mH. Actual values were copper wire 2.01 mm and inductance 0.98 mH.

## **Design Verification through Test**



Figure 8. Full Load Test Results (at 9.69 Arms)

It was verified that the maximum ripple current of inductor current is about 4  $A_{PK_PK}$ , which is similar to the assumption of  $\Delta I_{LP_P}$  in Equation (3).

# References

AN-42047 — Power Factor Correction (PFC) Basics

<u>AN-6982 — Power Factor Correction Converter Design</u> <u>with FAN6982</u>

Magnetic Powder Cores: http://www.changsung.com/

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